



SYMMETRIC DUAL N-CHANNEL MOSFET PowerDI3333-8

Product Summary

Device	BV _{DSS}	R _{DS(ON)} Max	I _D Max Tc = +25°C
Q1	30V	2.5mΩ @V _{GS} = 10V	47A
	307	$3.2 \text{m}\Omega @V_{GS} = 4.5 \text{V}$	42A
Q2	201/	2.9mΩ @V _{GS} = 10V	47A
	30V	$3.6 \text{m}\Omega @V_{GS} = 4.5 \text{V}$	42A

Description

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

• Power management functions

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

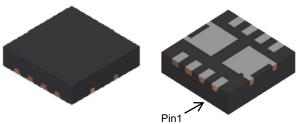
D2

- Package: PowerDI[®]3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Lead Frame.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (Approximate)

G2

D1/S2

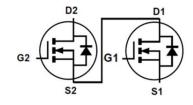




Pin1

Bottom View

Bottom View



Q2 N-Channel MOSFET Q1 N-Channel MOSFET

Ordering Information (Note 4)

Top View

Part Number	Package	Pac	Packing		
Fait Number	Fackage	Qty.	Carrier		
DMT32M6LDG-7	PowerDI3333-8 (Type G)	2,000	Tape & Reel		
DMT32M6LDG-13	PowerDI3333-8 (Type G)	3,000	Tape & Reel		

Notes:

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

D2

D2

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



S26 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 22 = 2022) WW = Week Code (01 to 53)



Maximum Ratings N-CHANNEL – Q1 & Q2 (@T_A = +25°C, unless otherwise specified.)

Charac	Symbol	Q1 N-CHANNEL	Q2 N-CHANNEL	Unit		
Drain-Source Voltage			VDSS	30	30	V
Gate-Source Voltage	Vgss	16 -12	16 -12	V		
Continuous Drain Current (Note 6)	Steady State	$T_A = +25$ °C $T_A = +70$ °C	ID	21 17	21 17	А
Continuous Drain Current (Note 7)	Steady State	$T_C = +25$ °C $T_C = +70$ °C	ID	47 38	47 38	А
Maximum Continuous Body Diode Forw	Is	2.7	2.7	Α		
Pulsed Drain Current (10µs Pulse, Duty	I _{DM}	110	110	Α		
Pulsed Body Diode Forward Current (10	lsм	110	110	А		
Avalanche Current (Note 8) L = 0.1mH	las	21	21	Α		
Avalanche Energy (Note 8) L = 0.1mH	Eas	22	22	mJ		

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	116	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	1.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	73	°C/W
Thermal Resistance, Junction to Case (Note 7)		Rejc	14.4	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25$ °C.



Electrical Characteristics N-CHANNEL - Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 9)								
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	V _{GS} = 0V, I _D = 250µA		
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	_	1.0	μΑ	V _{DS} = 24V, V _{GS} = 0V		
Gate-Source Leakage	Igss	_	_	100	nA	V _G S = 16V, V _D S = 0V		
Gate-Source Leakage	I _{GSS}	_	_	-100	nA	V _{GS} = -12V, V _{DS} = 0V		
ON CHARACTERISTICS (Note 9)	•			•		•		
Gate Threshold Voltage	Vgs(th)	1	_	2.2	V	$V_{DS} = V_{GS}$, $I_D = 400 \mu A$		
Static Drain-Source On-Resistance	D	_	1.7	2.5	mΩ	V _G S = 10V, I _D = 18A		
Static Drain-Source On-Resistance	R _{DS(ON)}	_	2.3	3.2	11122	V _{GS} = 4.5V, I _D = 16A		
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 18A		
DYNAMIC CHARACTERISTICS (Note 10)	DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss	_	2101	_	pF	45)/)/ 6)/		
Output Capacitance	Coss	_	1488	_	pF	V _{DS} = 15V, V _{GS} = 0V, -f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	73	_	pF	-1 = 1.0MH2		
Gate Resistance	Rg	_	0.55	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	15.6	_	nC			
Total Gate Charge (V _{GS} = 10V)	Qg	_	31.7	_	nC	V _{GS} = 4.5V, V _{DS} = 15V,		
Gate-Source Charge	Qgs	_	3.9	_	nC	I _D = 18A		
Gate-Drain Charge	Qgd	-	5	_	nC	7		
Turn-On Delay Time	t _{D(ON)}	-	8.7	_	ns			
Turn-On Rise Time	tR	-	32.4	_	ns	1,, 45,4 5, 60, 40,4		
Turn-Off Delay Time	tD(OFF)	-	36.2	_	ns	$V_{DS} = 15V$, $R_G = 6\Omega$, $I_D = 18A$		
Turn-Off Fall Time	tr	_	15.4	_	ns	1		
Reverse Recovery Time	t _{RR}	_	37	_	ns	1 154 11/11 1004/		
Reverse Recovery Charge	Q _{RR}	_	29.8	_	nC	- I _F = 15A, dI/dt = 100A/μs		

Notes:

^{9.} Short duration pulse test used to minimize self-heating effect.

^{10.} Guaranteed by design. Not subject to product testing.



Electrical Characteristics N-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	30	_	_	V	V _G S = 0V, I _D = 250μA	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS	_	_	1.0	μΑ	V _{DS} = 24V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	100	nA	Vgs = 16V, Vps = 0V	
Gate-Source Leakage	I _{GSS}	_	_	-100	nA	V _{GS} = -12V, V _{DS} = 0V	
ON CHARACTERISTICS (Note 9)	•			•	•		
Gate Threshold Voltage	Vgs(th)	1	_	2.2	V	$V_{DS} = V_{GS}$, $I_D = 400 \mu A$	
Static Drain-Source On-Resistance	D-acaus	_	2.1	2.9	mΩ	V _G S = 10V, I _D = 18A	
Static Dialit-Source Off-Resistance	R _{DS(ON)}	_	2.7	3.6	11122	$V_{GS} = 4.5V, I_D = 16A$	
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 18A	
DYNAMIC CHARACTERISTICS (Note 10)	•			•	•		
Input Capacitance	Ciss	_	2106	_	pF	V 45V V 9V	
Output Capacitance	Coss	_	1491	_	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	73	_	pF		
Gate Resistance	Rg	_	0.55		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	15.1	_	nC		
Total Gate Charge (V _{GS} = 10V)	Qg	_	32	_	nC	$V_{GS} = 4.5V, V_{DS} = 15V,$	
Gate-Source Charge	Qgs	_	3.7	_	nC	I _D = 18A	
Gate-Drain Charge	Qgd	_	4.4	_	nC	1	
Turn-On Delay Time	t _{D(ON)}	_	9.3	_	ns		
Turn-On Rise Time	tR	_	30.6	_	ns	V _{DS} = 15V, R _G = 6Ω, I _D = 18A	
Turn-Off Delay Time	tD(OFF)	_	35	_	ns		
Turn-Off Fall Time	tr	_	15.1	_	ns		
Reverse Recovery Time	t _{RR}	_	35.8	_	ns	454 11/14 4004/	
Reverse Recovery Charge	Q _{RR}	_	28.7	_	nC	IF = 15A, dI/dt = 100A/µs	

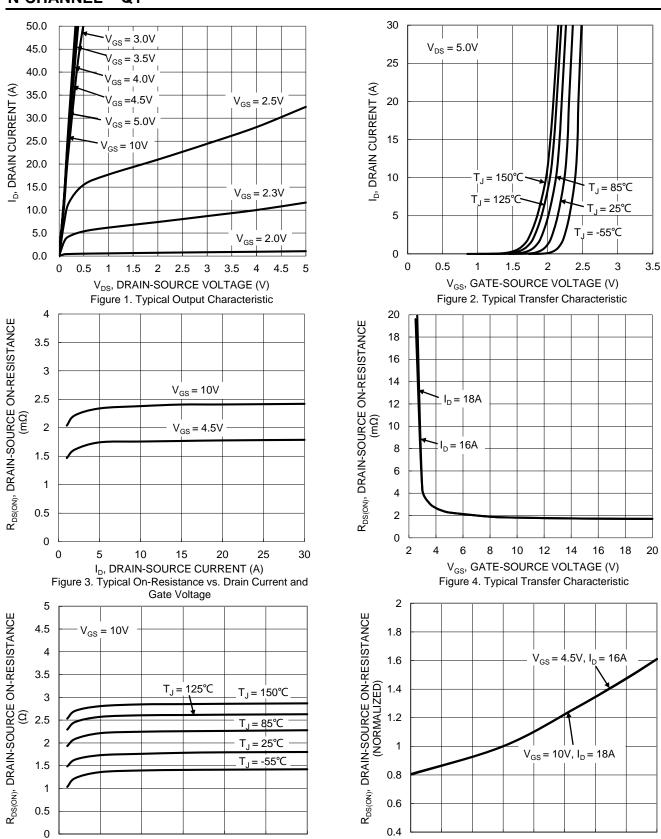
Notes:

^{9.} Short duration pulse test used to minimize self-heating effect.

^{10.} Guaranteed by design. Not subject to product testing.



N-CHANNEL - Q1



10

15

I_D, DRAIN CURRENT (A)

Figure 5. Typical On-Resistance vs. Drain Current and

Temperature

20

25

30

0

-25

-50

0

25

50

T₁, JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Temperature

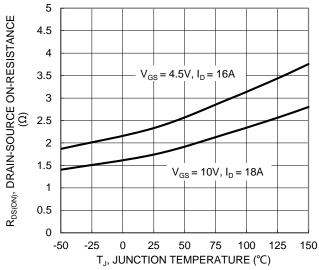
75

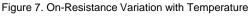
100

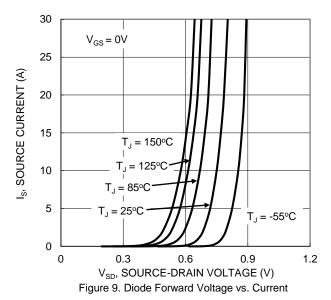
125

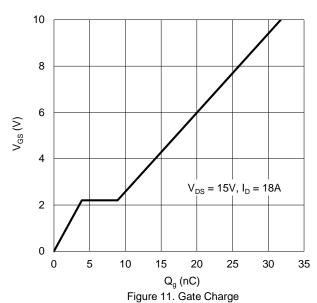
150











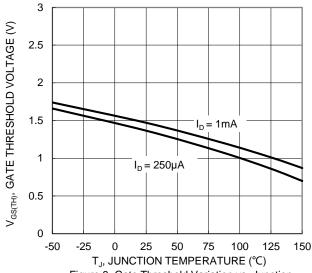
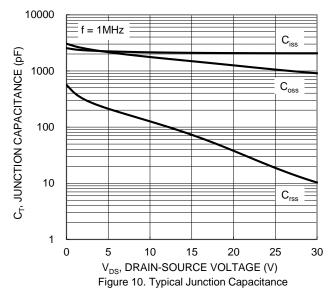
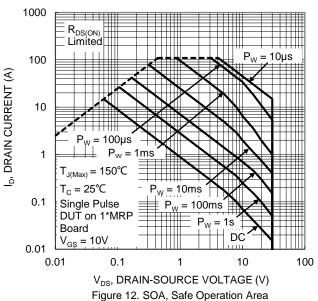


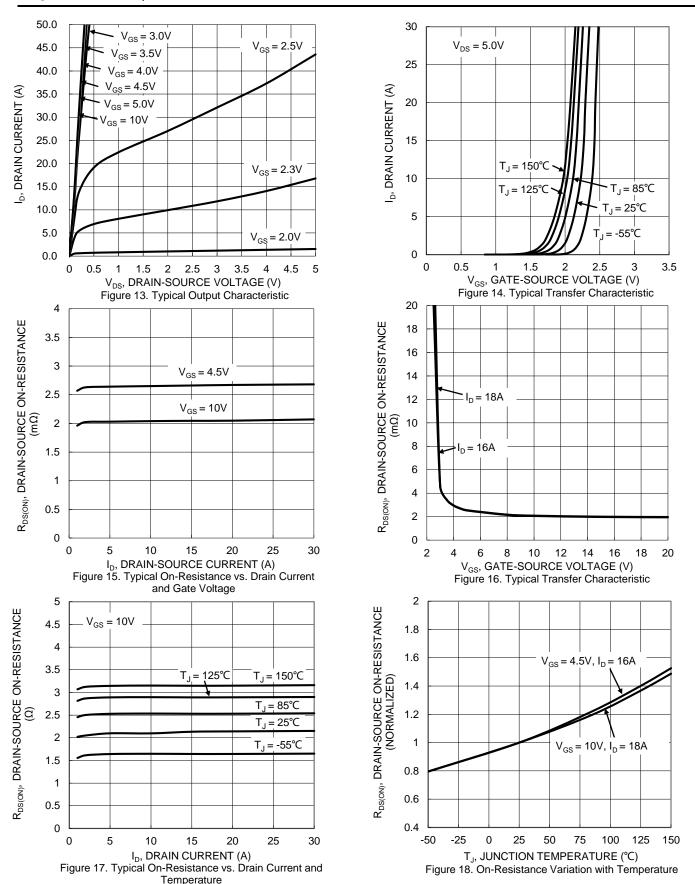
Figure 8. Gate Threshold Variation vs. Junction Temperature



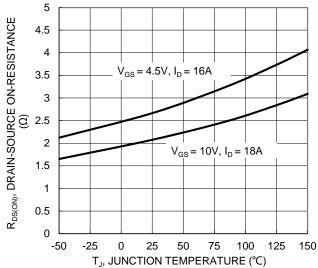


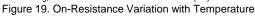


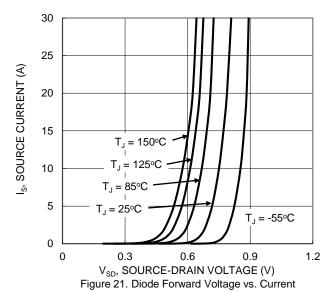
N-CHANNEL - Q2

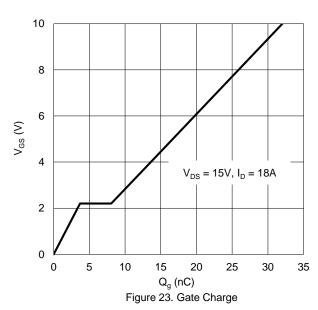












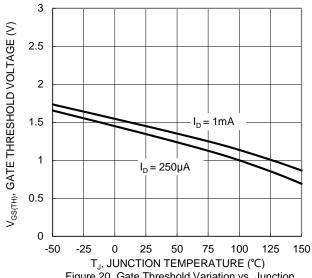
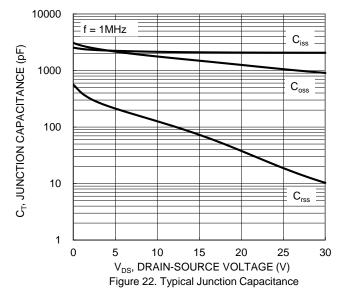
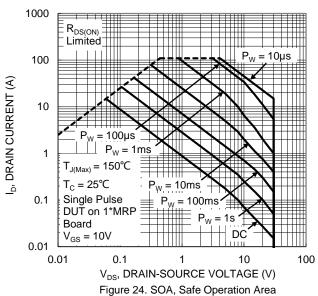


Figure 20. Gate Threshold Variation vs. Junction Temperature







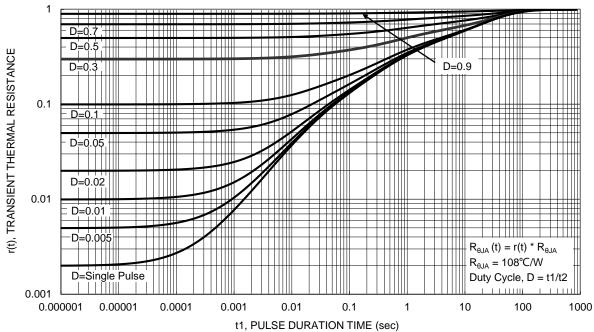


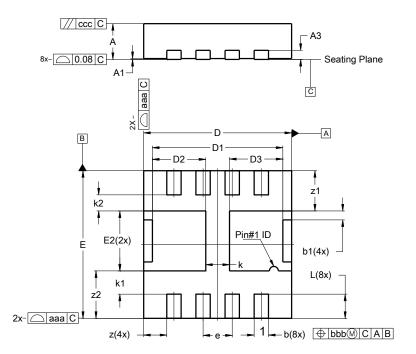
Figure 25. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type G)

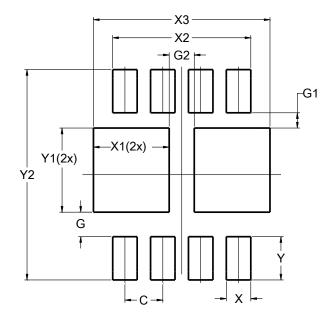


PowerDI3333-8 (Type G)						
Dim	Min	Max	Тур			
Α	0.75	0.85	0.80			
A1	0.00	0.05	0.02			
A3			0.203			
b	0.27	0.37	0.32			
b1	0.15	0.25	0.20			
D	3.25	3.35	3.30			
D1	2.81	3.01	2.91			
D2	1.09	1.29	1.19			
D3	1.09	1.29	1.19			
E	3.25	3.35	3.30			
E2	1.24	1.44	1.34			
е	0.65BSC					
L	0.49	0.59	0.54			
k			0.53			
k1			0.52			
k2			0.36			
Z			0.515			
z 1			0.90			
z2			1.06			
aaa	0.25					
bbb	0.10					
CCC	0.10					
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type G)



Dimensions	Value		
Dillicitorio	(in mm)		
С	0.650		
G	0.420		
G1	0.260		
G2	0.430		
Х	0.420		
X1	1.300		
X2	2.370		
Х3	3.030		
Υ	0.740		
Y1	1.440		
Y2	3.600		



IMPORTANT NOTICE

- 1. DIODES INCORPORATED (Diodes) AND ITS SUBSIDIARIES MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).
- 2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes' products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes' products. Diodes' products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of Diodes' products for their intended applications, (c) ensuring their applications, which incorporate Diodes' products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.
- 3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.
- 4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.
- 5. Diodes' products are provided subject to Diodes' Standard Terms and Conditions of Sale (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.
- 6. Diodes' products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes' products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.
- 7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.
- 8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.
- 9. This Notice may be periodically updated with the most recent version available at https://www.diodes.com/about/company/terms-and-conditions/important-notice

The Diodes logo is a registered trademark of Diodes Incorporated in the United States and other countries. DIODES is a trademark of Diodes Incorporated in the United States and other countries. All other trademarks are the property of their respective owners.

© 2022 Diodes Incorporated. All Rights Reserved.

www.diodes.com